Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	70	("438"/$.ccls. "257"/$.ccls.) and (diced dicing sawing) same IC adj2 (die chip) same test$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/04 09:54
L2	1	10/195527	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/04 09:54
S53	1993	(257/737).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/02 13:52
S54	1719	(257/738).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/02 13:52
S55	103	(S53 S54) and diffusion near barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 14:27
S56	1390	(257/751).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/02 13:52
S57	309	S56 and (Ni Nickel)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52
S58	102	S57 and pad	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52
S59	0	("6798050").URPN.	USPAT	OR	ON	2005/09/02 13:52
S60	80	(S53 S54) and (Ni nickel) and diffusion near barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52
S61	23	S55 not S60	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52
S62	95	S58 not S55	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52

S63	5	("20020000665" | "3826886" | "5631499" | "5767010" | "6187680").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/02 13:52
S64	1063	(438/653).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/02 13:52
S65	360	(438/654).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/02 13:52
S66	70	(S64 S65) and (Ni nickel) and pad	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/02 13:52
S67	7	("3633076" | "5162257" | "5937320" | "6232212" | "6452270" | "6696356" | "6756184").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/02 13:52
S68	0	("6897141").URPN.	USPAT	OR	ON	2005/09/02 13:52
S69	1	("6706622").URPN.	USPAT	OR	ON	2005/09/02 13:52
S70	5	("6180505" | "6358831" | "6403457" | "6444568" | "6458690").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/09/02 13:52
S71	2557	(438/612).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/02 13:52
S72	2105	(438/614).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/02 13:52
S73	97	(S71 S72) and (Ni nickel Pd palladium) and diffusion near barrier and adhesion	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/02 13:52
S74	87	S73 not (S58 S55 S60)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/02 13:52
S75	385	S56 and (Ni nickel Pd palladium)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/02 13:52
S76	185	S56 and (Ni nickel Pd palladium) and adhesion	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/02 13:52
S77	118	S76 not (S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/02 13:52

S78	1309	(257/E23.02).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/02 13:52
S79	128	(S71 S72) and (Ni nickel Pd palladium) and diffusion near barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 15:42
S80	23	S79 not (S76 S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52
S81	492	(257/753).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/02 13:52
S82	67	S56 and (Pd palladium) and pad	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52
S83	9	S82 not (S79 S76 S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52
S84	114	S81 and (Ni nickel)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52
S85	96	S84 not (S79 S76 S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52
S86	63	S78 and (ni nickel pd palladium) and diffusion near2 barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52
S87	41	S86 not (S84 S79 S76 S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52
S88	287	S56 and pad	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 13:52
S89	175	S88 not (S86 S84 S79 S76 S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 14:27

S90	2096	(257/E23.021).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/02 14:26
S91	575	S90 and (ni nickel) and barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 14:26
S93	392	(S53 S54) and barrier and (Ni nickel)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 14:27
S94	289	S93 not (S88 S86 S84 S79 S76 S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 15:42
S95	754	(257/766).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/02 15:41
S96	224	S95 and barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 15:41
S97	172	S96 not (S93 S88 S86 S84 S79 S76 S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 15:44
S98	449	(S71 S72) and (Ni nickel Pd palladium) and barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 17:04
S99	268	S98 not (S96 S93 S88 S86 S84 S79 S76 S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 16:00
S100	1329	(257/750).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/02 15:43
S101	842	(438/652).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/02 15:44
S102	262	(S64 S65) and (Ni nickel Pd palladium) and barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 15:46

S107	181	S102 not (S98 S96 S93 S88 S86 S84 S79 S76 S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02.16:43
S108	61	(S100 S101) and barrier and adhesion and pad and (nickel palladium pd ni)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02.16:37
S109	25	S108 not (S102 S98 S96 S93 S88 S86 S84 S79 S76 S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 17:06
S110	1	(257/E21.523).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/02 16:39
S111	1327	(257/48).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	OFF	2005/09/02 16:39
S113	68	S111 and barrier and pad	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 16:40
S114	134	S75 not (S98 S96 S93 S88 S86 S84 S79 S76 S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 16:43
S115	410	(S53 S54) and (Ni nickel Pd palladium) and barrier	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 17:04
S116	18	S115 not S93	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 17:05
S117	389	seed and adhesion and barrier and (ni nickel) and (gold au) and (contact bond$3 terminal) adj pad	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 17:06
S118	288	S117 not (S108 S102 S98 S96 S93 S88 S86 S84 S79 S76 S58 S60 S55 S73 S66)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 17:06
S132	22	(tien adj jen near3 cheng).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/02 18:01

S133	22	(tien adj jen near3 cheng).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 09:27
S134	10	(david near3 eichstadt).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 09:28
S135	3	S134 not S133	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 09:28
S136	45	(griffith near3 jonathan).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 09:29
S137	38	S136 not (S133 S134)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 09:29
S138	21	(samuel near3 mcknight).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 09:30
S139	20	S138 not (S133 S134 S136)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 09:54
S140	89	(kevin near3 petrarca).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 09:55
S141	71	S140 not (S138 S133 S134 S136)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 09:59
S142	29	(kamalesh near3 srivastava).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 09:59
S143	22	S142 not (S133 S134 S136 S138 S140)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 10:00
S144	7	(roger near3 quon).in.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 10:00

S146	3401	438/14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 15:58
S147	148	S146 and IC adj chips	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 16:52
S148	178	"438"/$.ccls. and (diced dicing) same IC adj2 chip	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/04 09:35
S149	9	S148 and (test$3 prob$3) adj pad	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT ; IBM_TDB	OR	ON	2005/09/03 17:13